

## 4/3/2/1-Phase PWM Controller for AMD AM2/AM2+ CPUs

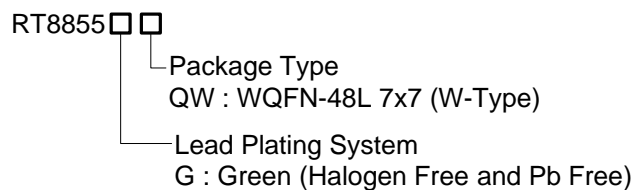
### General Description

The RT8855 is a 4/3/2/1-phase synchronous buck controller with two integrated MOSFET drivers for CPU power application and a single-phase buck with integrated MOSFET driver for North-Bridge (NB) chipset. The RT8855 uses differential inductor DCR current sense to achieve phase current balance and active voltage positioning. Other features include adjustable operating frequency, power good indication, external error-amp compensation, over voltage protection, over current protection and enable/shutdown for various applications. The RT8855 comes to a small footprint with WQFN-48L 7x7 package.

### Applications

- Desktop CPU Core Power
- Low Voltage, High Current DC/DC Converter

### Ordering Information



Note :

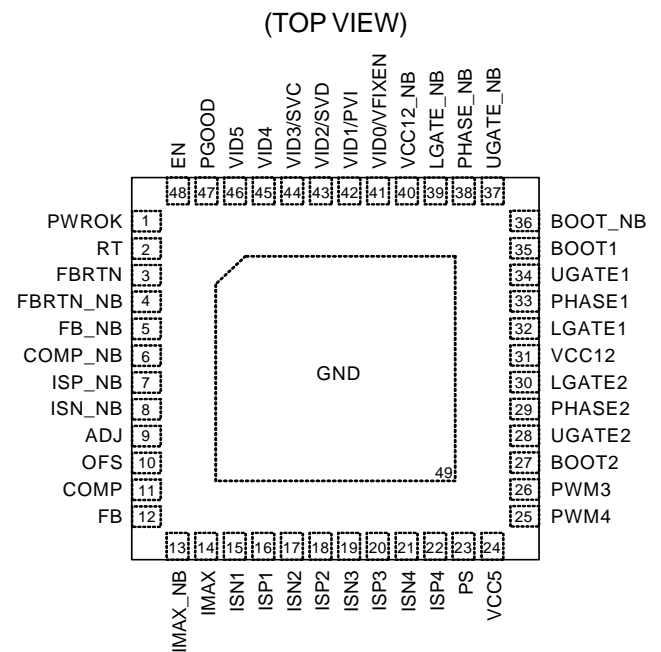
Richtek products are :

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

### Features

- 12V Power Supply Voltage
- 4/3/2/1-Phase Power Conversion for V<sub>CORE</sub> Power
- 3 Embedded MOSFET Drivers (2 for CPU and 1 for NB)
- Internal Regulated 5V Output
- Support AMD AM2 6-bit Parallel and AM2+ 7-bit Serial VID Tables
- Continuous Differential Inductor DCR Current Sense
- Adjustable Frequency (Typically at 300kHz)
- Selectable 1 or 2 Phase in Power-Saving (PS) Mode
- Phase-Interleaving for V<sub>CORE</sub> and NB Controller
- Power Good Indication
- Adjustable Over Current Protection
- Over Voltage Protection
- Small 48-Lead WQFN Package
- RoHS Compliant and Halogen Free

### Pin Configurations



WQFN-48L 7x7

## Part Status

| Part No   | Status   | Package Type | Lead plating System              |
|-----------|----------|--------------|----------------------------------|
| RT8855GQW | Obsolete | WQFN-48L 7x7 | Green (Halogen Free and Pb Free) |

The part status values are defined as follows:

**Active:** Device is in production and is recommended for new designs.

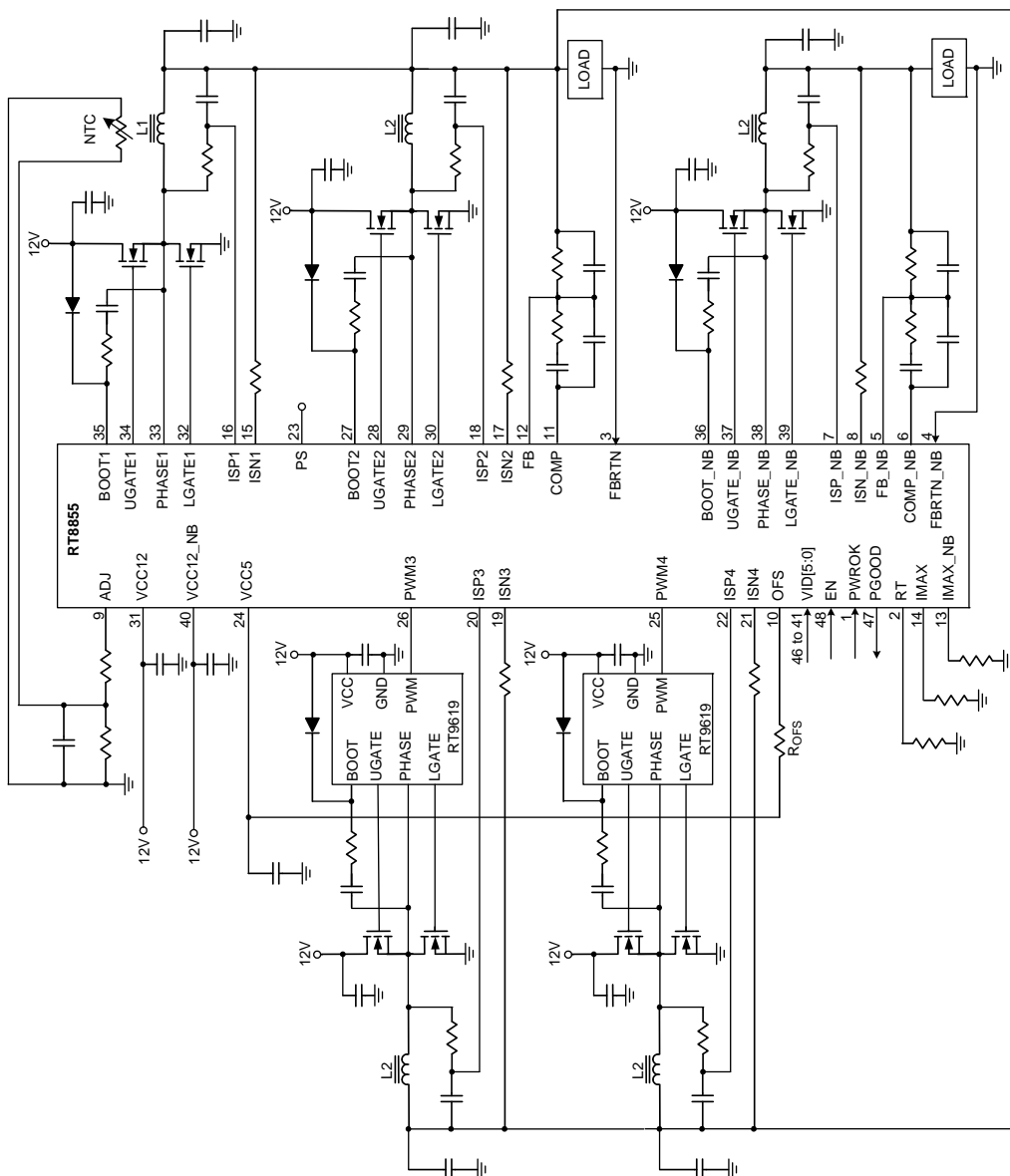
**Lifebuy:** The device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs.

**Preview:** Device has been announced but is not in production.

**Obsolete:** Richtek has discontinued the production of the device.

## Typical Application Circuit



**Table 1. 7-bit VID Code Table for AM2+ CPU (Serial)**

| SVID[6:0] | Voltage | SVID[6:0] | Voltage | SVID[6:0] | Voltage | SVID[6:0] | Voltage |
|-----------|---------|-----------|---------|-----------|---------|-----------|---------|
| 0000000   | 1.5500  | 0100000   | 1.1500  | 1000000   | 0.7500  | 1100000   | 0.3500  |
| 0000001   | 1.5375  | 0100001   | 1.1375  | 1000001   | 0.7375  | 1100001   | 0.3375  |
| 0000010   | 1.5250  | 0100010   | 1.1250  | 1000010   | 0.7250  | 1100010   | 0.3250  |
| 0000011   | 1.5125  | 0100011   | 1.1125  | 1000011   | 0.7125  | 1100011   | 0.3125  |
| 0000100   | 1.5000  | 0100100   | 1.1000  | 1000100   | 0.7000  | 1100100   | 0.3000  |
| 0000101   | 1.4875  | 0100101   | 1.0875  | 1000101   | 0.6875  | 1100101   | 0.2875  |
| 0000110   | 1.4750  | 0100110   | 1.0750  | 1000110   | 0.6750  | 1100110   | 0.2750  |
| 0000111   | 1.4625  | 0100111   | 1.0625  | 1000111   | 0.6625  | 1100111   | 0.2625  |
| 0001000   | 1.4500  | 0101000   | 1.0500  | 1001000   | 0.6500  | 1101000   | 0.2500  |
| 0001001   | 1.4375  | 0101001   | 1.0375  | 1001001   | 0.6375  | 1101001   | 0.2375  |
| 0001010   | 1.4250  | 0101010   | 1.0250  | 1001010   | 0.6250  | 1101010   | 0.2250  |
| 0001011   | 1.4125  | 0101011   | 1.0125  | 1001011   | 0.6125  | 1101011   | 0.2125  |
| 0001100   | 1.4000  | 0101100   | 1.0000  | 1001100   | 0.6000  | 1101100   | 0.2000  |
| 0001101   | 1.3875  | 0101101   | 0.9875  | 1001101   | 0.5875  | 1101101   | 0.1875  |
| 0001110   | 1.3750  | 0101110   | 0.9750  | 1001110   | 0.5750  | 1101110   | 0.1750  |
| 0001111   | 1.3625  | 0101111   | 0.9625  | 1001111   | 0.5625  | 1101111   | 0.1625  |
| 0010000   | 1.3500  | 0110000   | 0.9500  | 1010000   | 0.5500  | 1110000   | 0.1500  |
| 0010001   | 1.3375  | 0110001   | 0.9375  | 1010001   | 0.5375  | 1110001   | 0.1375  |
| 0010010   | 1.3250  | 0110010   | 0.9250  | 1010010   | 0.5250  | 1110010   | 0.1250  |
| 0010011   | 1.3125  | 0110011   | 0.9125  | 1010011   | 0.5125  | 1110011   | 0.1125  |
| 0010100   | 1.3000  | 0110100   | 0.9000  | 1010100   | 0.5000  | 1110100   | 0.1000  |
| 0010101   | 1.2875  | 0110101   | 0.8875  | 1010101   | 0.4875  | 1110101   | 0.0875  |
| 0010110   | 1.2750  | 0110110   | 0.8750  | 1010110   | 0.4750  | 1110110   | 0.0750  |
| 0010111   | 1.2625  | 0110111   | 0.8625  | 1010111   | 0.4625  | 1110111   | 0.0675  |
| 0011000   | 1.2500  | 0111000   | 0.8500  | 1011000   | 0.4500  | 1111000   | 0.0500  |
| 0011001   | 1.2375  | 0111001   | 0.8375  | 1011001   | 0.4375  | 1111001   | 0.0375  |
| 0011010   | 1.2250  | 0111010   | 0.8250  | 1011010   | 0.4250  | 1111010   | 0.0250  |
| 0011011   | 1.2125  | 0111011   | 0.8125  | 1011011   | 0.4125  | 1111011   | 0.0125  |
| 0011100   | 1.2000  | 0111100   | 0.8000  | 1011100   | 0.4000  | 1111100   | OFF     |
| 0011101   | 1.1875  | 0111101   | 0.7875  | 1011101   | 0.3875  | 1111101   | OFF     |
| 0011110   | 1.1750  | 0111110   | 0.7750  | 1011110   | 0.3750  | 1111110   | OFF     |
| 0011111   | 1.1625  | 0111111   | 0.7625  | 1011111   | 0.3625  | 1111111   | OFF     |

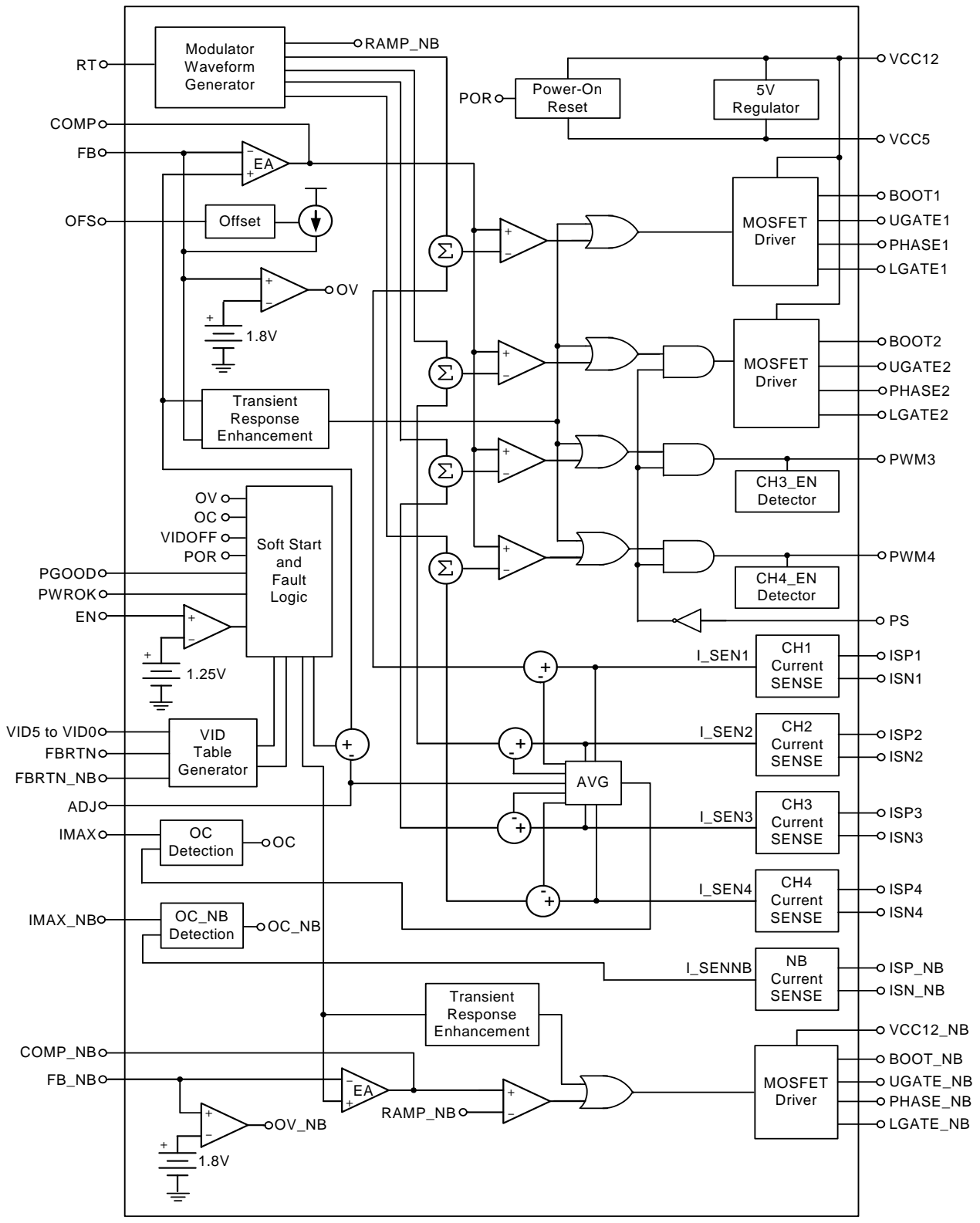
**Table 2. 6-bit VID Code Table for AM2 CPU (Parallel)**

| <b>VID[5:0]</b> | <b>Voltage</b> | <b>VID[5:0]</b> | <b>Voltage</b> | <b>VID[5:0]</b> | <b>Voltage</b> | <b>VID[5:0]</b> | <b>Voltage</b> |
|-----------------|----------------|-----------------|----------------|-----------------|----------------|-----------------|----------------|
| 000000          | 1.5500         | 010000          | 1.1500         | 100000          | 0.7625         | 110000          | 0.5625         |
| 000001          | 1.5250         | 010001          | 1.1250         | 100001          | 0.7500         | 110001          | 0.5500         |
| 000010          | 1.5000         | 010010          | 1.1000         | 100010          | 0.7375         | 110010          | 0.5375         |
| 000011          | 1.4750         | 010011          | 1.0750         | 100011          | 0.7250         | 110011          | 0.5250         |
| 000100          | 1.4500         | 010100          | 1.0500         | 100100          | 0.7125         | 110100          | 0.5125         |
| 000101          | 1.4250         | 010101          | 1.0250         | 100101          | 0.7000         | 110101          | 0.5000         |
| 000110          | 1.4000         | 010110          | 1.0000         | 100110          | 0.6875         | 110110          | 0.4875         |
| 000111          | 1.3750         | 010111          | 0.9750         | 100111          | 0.6750         | 110111          | 0.4750         |
| 001000          | 1.3500         | 011000          | 0.9500         | 101000          | 0.6625         | 111000          | 0.4625         |
| 001001          | 1.3250         | 011001          | 0.9250         | 101001          | 0.6500         | 111001          | 0.4500         |
| 001010          | 1.3000         | 011010          | 0.9000         | 101010          | 0.6375         | 111010          | 0.4375         |
| 001011          | 1.2750         | 011011          | 0.8750         | 101011          | 0.6250         | 111011          | 0.4250         |
| 001100          | 1.2500         | 011100          | 0.8500         | 101100          | 0.6125         | 111100          | 0.4125         |
| 001101          | 1.2250         | 011101          | 0.8250         | 101101          | 0.6000         | 111101          | 0.4000         |
| 001110          | 1.2000         | 011110          | 0.8000         | 101110          | 0.5875         | 111110          | 0.3875         |
| 001111          | 1.1750         | 011111          | 0.7750         | 101111          | 0.5750         | 111111          | 0.3750         |

**Functional Pin Description**

| Pin No.          | Pin Name                 | Pin Function   |
|------------------|--------------------------|--|
| 1                | PWROK                    | PWROK Input Signal.  |
| 2                | RT                       | Connect this pin to GND by a resistor to adjust frequency.   |
| 3                | FBRTN                    | Remote sense ground for CORE.  |
| 4                | FBRTN_NB                 | Remote sense ground for NB.  |
| 5                | FB_NB                    | Inverting input of error-amp for NB.   |
| 6                | COMP_NB                  | Output of error-amp and input of PWM comparator for NB.  |
| 7                | ISP_NB                   | Positive current sense pin of NB   |
| 8                | ISN_NB                   | Negative current sense pin of NB   |
| 9                | ADJ                      | Connect this pin to GND by a resistor to set load line of V <sub>CORE</sub> .  |
| 10               | OFS                      | Connect this pin to GND/5VCC by a resistor to set no-load offset voltage of V <sub>CORE</sub> .  |
| 11               | COMP                     | Output of error-amp and input of PWM comparator of V <sub>CORE</sub> .   |
| 12               | FB                       | Inverting input of error-amp of V <sub>CORE</sub> .  |
| 13               | IMAX_NB                  | Connect this pin to GND by a resistor to set OCP of NB.  |
| 14               | IMAX                     | Connect this pin to GND by a resistor to set OCP of V <sub>CORE</sub> .  |
| 15, 17, 19, 21   | ISN1, ISN2, ISN3, ISN4   | Negative current sense pin of channel 1, 2, 3 and 4.   |
| 16, 18, 20, 22   | ISP1, ISP2, ISP3, ISP4   | Positive current sense pin of channel 1, 2, 3 and 4.   |
| 23               | PS                       | Power Saving Mode Selection Pin.   |
| 24               | VCC5                     | Output of internal 5V regulator for control circuits power supply. Connect this pin to GND by a ceramic capacitor larger than 1uF.           |
| 25,26            | PWM4, PWM3               | PWM output for channel 4 and channel 3.  |
| 27, 35, 36       | BOOT2, BOOT1, BOOT_NB    | Bootstrap supply for channel 2 and channel 1 and NB.   |
| 28, 34, 37       | UGATE2, UGATE1, UGATE_NB | Upper gate driver for channel 2 and channel 1 and NB.  |
| 29, 33, 38       | PHASE2, PHASE1, PHASE_NB | Switching node of channel 2 and channel 1 and NB.  |
| 30, 32, 39       | LGATE2, LGATE1, LGATE_NB | Lower gate driver for channel 2 and channel 1 and NB.  |
| 31, 40           | VCC12, VCC12_NB          | IC power supply. Connect this pin to 12V.  |
| 41               | VID0/VFIXEN              | PVI Mode : Used as voltage identification input for DAC.<br>SVI Mode : Functions as VFIXEN selection input.                                  |
| 42               | VID1/PVI                 | This pin selects PVI/SVI mode based on the state of this pin prior to EN signal.<br>PVI Mode : Used as voltage identification input for DAC. |
| 43               | VID2/SVD                 | PVI Mode : Used as voltage identification input for DAC.<br>SVI Mode : Serial data input.  |
| 44               | VID3/SVC                 | PVI Mode : Used as voltage identification input for DAC.<br>SVI Mode : Serial clock input.   |
| 45, 46           | VID4, VID5               | PVI Mode : Used as voltage identification input for DAC.   |
| 47               | PGOOD                    | Power Good Indicator (open drain).   |
| 48               | EN                       | Enable Input Signal.   |
| Exposed pad (49) | GND                      | Reference Ground for the IC. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.             |

Function Block Diagram



**Absolute Maximum Ratings** (Note 1)

- Supply Input Voltage ----- -0.3V to 15V
- BOOTx to PHASEx ----- -0.3V to 15V
- BOOTx to GND
  - DC ----- -0.3V to 30V
  - <200ns ----- -0.3V to 42V
- PHASEx to GND
  - DC ----- -2V to 15V
  - <200ns ----- -5V to 30V
- Input/Output Voltage or I/O Voltage ----- -0.3V to 7V
- Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C
  - WQFN-48L 7x7 ----- 3.226W
- Package Thermal Resistance (Note 2)
  - WQFN-48L 7x7, θ<sub>JA</sub> ----- 31°C/W
- Junction Temperature ----- 150°C
- Lead Temperature (Soldering, 10 sec.) ----- 260°C
- Storage Temperature Range ----- -65°C to 150°C
- ESD Susceptibility (Note 3)
  - HBM (Human Body Mode) ----- 2kV
  - MM (Machine Mode) ----- 200V

**Recommended Operating Conditions** (Note 4)

- Supply Voltage, V<sub>CC12</sub> ----- 12V ± 10%
- Junction Temperature Range ----- -40°C to 125°C
- Ambient Temperature Range ----- 0°C to 70°C

**Electrical Characteristics**

(V<sub>CC12</sub> = 12V, GND = 0V, T<sub>A</sub> = 25°C, unless otherwise specified)

| Parameter                   | Symbol                | Test Conditions          | Min  | Typ | Max  | Unit |
|-----------------------------|-----------------------|--------------------------|------|-----|------|------|
| <b>VCC Supply Input</b>     |                       |                          |      |     |      |      |
| VCC12 Supply Voltage        | V <sub>VCC12</sub>    |                          | 10.8 | 12  | 13.2 | V    |
| VCC12 Supply Current        | I <sub>VCC12</sub>    |                          | --   | 10  | --   | mA   |
| VCC12_NB Supply Voltage     | V <sub>VCC12_NB</sub> |                          | 10.8 | 12  | 13.2 | V    |
| VCC12_NB Supply Current     | I <sub>VCC12_NB</sub> |                          | --   | 5   | --   | mA   |
| <b>VCC5 Power</b>           |                       |                          |      |     |      |      |
| VCC5 Supply Voltage         | V <sub>VCC5</sub>     | I <sub>LOAD</sub> = 10mA | 4.9  | 5   | 5.1  | V    |
| VCC5 Output Sourcing        | I <sub>VCC5</sub>     |                          | 10   | --  | --   | mA   |
| <b>Power-On Reset</b>       |                       |                          |      |     |      |      |
| VCC12 Rising Threshold      | V <sub>VCC12TH</sub>  | VCC12 Rising             | 9.2  | 9.6 | 10   | V    |
| VCC12 Hysteresis            | V <sub>VCC12HY</sub>  | VCC12 Falling            | --   | 0.9 | --   | V    |
| <b>Input Threshold</b>      |                       |                          |      |     |      |      |
| Enable Input High Threshold | V <sub>ENHI</sub>     | EN Rising                | 2    | --  | --   | V    |
| Enable Input Low Threshold  | V <sub>ENLO</sub>     | EN Falling               | --   | --  | 0.8  | V    |

| Parameter                         | Symbol                     | Test Conditions                                  | Min            | Typ            | Max            | Unit  |
|-----------------------------------|----------------------------|--|----------------|----------------|----------------|-------|
| PWROK Input High Threshold        | V <sub>POKHI</sub>         | PWROK Rising                                     | 2              | --             | --             | V     |
| PWROK Input Low Threshold         | V <sub>POKLO</sub>         | PWROK Falling                                    | --             | --             | 0.8            | V     |
| VID5 to VID0 Rising Threshold     | V <sub>VID5 to 0</sub>     | VID5 to VID0 Rising                              | 0.75           | 0.8            | 0.85           | V     |
| VID5 to VID0 Hysteresis           | V <sub>VID5 to 0 HYS</sub> | VID5 to VID0 Falling                             | --             | 25             | --             | mV    |
| VID5 to VID0 Pull-Down Current    | I <sub>VID5 to 0</sub>     | V <sub>VID5 to 0</sub> = 1.5V                    | --             | 16             | 30             | uA    |
| <b>Reference Voltage accuracy</b> |                            |  |                |                |                |       |
| DAC Accuracy                      |                            | 1V to 1.55V                                      | -0.5           | --             | +0.5           | %     |
|                                   |                            | 0.8V to 1V                                       | -8             | --             | +8             | mV    |
|                                   |                            | 0.5V to 0.8V                                     | -10            | --             | +10            | mV    |
| <b>Error Amplifier</b>            |                            |  |                |                |                |       |
| DC Gain                           | A <sub>DC</sub>            | No Load  | --             | 80             | --             | dB    |
| Gain-Bandwidth                    | GBW                        | C <sub>LOAD</sub> = 10pF                         | --             | 10             | --             | MHz   |
| Slew Rate                         | SR                         | C <sub>LOAD</sub> = 10pF                         | 10             | --             | --             | V/us  |
| Output Voltage Range              | V <sub>COMP</sub>          | R <sub>LOAD</sub> = 47kΩ                         | 0.5            | --             | 3.6            | V     |
| <b>Power Good</b>                 |                            |  |                |                |                |       |
| Over-Voltage Threshold            | V <sub>PGOOD-OV</sub>      | FB Rising  | VDAC<br>+210mV | VDAC<br>+240mV | VDAC<br>+270mV | V     |
| Under-Voltage Threshold           | V <sub>PGOOD-UV</sub>      | FB Falling                                       | VDAC<br>-330mV | VDAC<br>-300mV | VDAC<br>-270mV | V     |
| Over-Voltage Threshold_NB         | V <sub>PGOOD-OV_NB</sub>   | FB_NB Rising                                     | VDAC<br>+210mV | VDAC<br>+240mV | VDAC<br>+270mV | V     |
| Under-Voltage Threshold_NB        | V <sub>PGOOD-UV_NB</sub>   | FB_NB Falling                                    | VDAC<br>-330mV | VDAC<br>-300mV | VDAC<br>-270mV | V     |
| Power Good Low Voltage            | V <sub>PGOOD</sub>         | I <sub>PGOOD</sub> = 4mA                         | --             | --             | 0.4            | V     |
| <b>Current Sense Amplifier</b>    |                            |  |                |                |                |       |
| Max Current                       | I <sub>GMMAX</sub>         | V <sub>CSP</sub> = 1.3V<br>Sink Current from CSN | 100            | --             | --             | uA    |
| Input Offset Voltage              | V <sub>OCS</sub>           |  | -2             | 0              | +2             | mV    |
| <b>Oscillator</b>                 |                            |  |                |                |                |       |
| Running Frequency                 | f <sub>OSC</sub>           | R <sub>RT</sub> = 40kΩ                           | 270            | 300            | 330            | kHz   |
| Ramp Amplitude                    | V <sub>RAMP</sub>          |  | --             | 1.6            | --             | V     |
| <b>Soft Start</b>                 |                            |  |                |                |                |       |
| Soft Start Slew Rate              | SR <sub>SS</sub>           | Slew Rate  | 2.5            | 3.25           | 4              | mV/us |
| VID change Slew Rate              | SR <sub>VID</sub>          | Slew Rate  | 2.5            | 3.25           | 4              | mV/us |
| <b>Protection</b>                 |                            |  |                |                |                |       |
| Over-Voltage Threshold            | V <sub>OVP</sub>           | Sweep FB Voltage                                 | 1.7            | 1.8            | 1.9            | V     |
|                                   | V <sub>OVP_NB</sub>        | Sweep FB_NB Voltage                              | 1.7            | 1.8            | 1.9            | V     |



| Parameter              | Symbol                | Test Conditions                           | Min  | Typ | Max  | Unit |
|------------------------|-----------------------|---|------|-----|------|------|
| Over-Current Threshold | I <sub>OC</sub> P     | R <sub>I</sub> MAX = 40kΩ                 | 68   | 80  | 92   | μA   |
|                        | V <sub>I</sub> MAX    | R <sub>I</sub> MAX = 40kΩ                 | 1.44 | 1.6 | 1.76 | V    |
|                        | I <sub>OC</sub> P_NB  | R <sub>I</sub> MAX_NB = 40kΩ              | 68   | 80  | 92   | μA   |
|                        | V <sub>I</sub> MAX_NB | R <sub>I</sub> MAX_NB = 40kΩ              | 1.44 | 1.6 | 1.76 | V    |
| <b>Gate Driver</b>     |                       |   |      |     |      |      |
| UGATE Drive Source     | R <sub>UGATE</sub> sr | BOOT – PHASE = 8V<br>250mA Source Current | --   | 1   | --   | Ω    |
| UGATE Drive Sink       | R <sub>UGATE</sub> sk | BOOT – PHASE = 8V<br>250mA Sink Current   | --   | 1   | --   | Ω    |
| LGATE Drive Source     | R <sub>LGATE</sub> sr | V <sub>LGATE</sub> = 8V                   | --   | 1   | --   | Ω    |
| LGATE Drive Sink       | R <sub>LGATE</sub> sk | 250mA Sink Current                        | --   | 0.9 | --   | Ω    |

**Note 1.** Stresses listed as the above “Absolute Maximum Ratings” may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

**Note 2.** θ<sub>JA</sub> is measured in the natural convection at T<sub>A</sub> = 25°C on a effective single layer thermal conductivity test board of JEDEC thermal measurement standard.

**Note 3.** Devices are ESD sensitive. Handling precaution is recommended.

**Note 4.** The device is not guaranteed to function outside its operating conditions.

## Application Information

The RT8855 is a dual output PWM controller supports hybrid power control of AMD processors which operate from either a 6-bit parallel VID interface (PVI) or a serial VID interface (SVI). One of the outputs is a 4/3/2/1-phase PWM controller with two integrated MOSFET drivers to support CPU core voltage (VDD) and another is a single-phase buck controller with an integrated MOSFET driver to power North-Bridge (NB) chipset (VDDNB) in SVI mode. In PVI mode, only multiphase PWM controller is active for single-plane VDD only processor.

Richtek's proprietary Burst Transient Response(BTR™), provides fastest initial response to high di/dt load transients and less bulk and ceramic output capacitance is required to meet transient regulation specifications. The RT8855 incorporates differential voltage sensing, continuous inductor DCR phase current sensing, programmable load-line voltage positioning and offset voltage to provide high accuracy regulated power for both VDD and VDDNB. While VDDNB is enabled in SVI mode, it will be automatically phase-shifted with respect to the CPU Core phases in order to reduce the total input RMS current amount.

### CPU\_TYPE Detection and System Start-Up

At system Start-up, on the rising-edge of EN signal, RT8855 monitors the status of VID1 and latches the PVI mode (VID1 = 1) or SVI mode (VID1 = 0).

### PVI Mode

PVI is a 6-bit-wide parallel interface used to address the CPU Core section reference. According to the selected code, the device sets the Core section reference and regulates its output voltage according to Table 2. In this mode, NB section is kept in high impedance. Furthermore, PWROK information is ignored as well since the signal only applies to the SVI protocol.

### SVI Mode

SVI is a two wire, Clock and Data, bus that connect a single master (CPU) to one slave (RT8855). The master initiates and terminates SVI transactions and drives the clock, SVC, and the data, SVD, during a transaction. The slave receives the SVI transactions and acts accordingly. SVI wire protocol is based on fast-mode I2C as shown in

Figure1. SVI interface also consider two additional signals needed to manage the system start-up. These signals are EN and PWROK. The device asserts a PGOOD signal if the output voltages are in regulation.

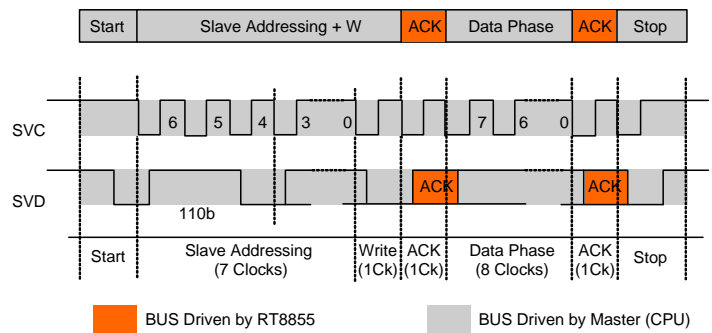


Figure 1. SVI Communication-Send Byte

### Set VID Command

The Set VID Command is defined as the command sequence that the CPU issues on the SVI bus to modify the voltage level of the Core section and NB section, as shown is Figure 1. During a Set VID Command, the processor sends the start (Start) sequence followed by the address of the Section which the Set VID Command applies. The processor then sends the write (WRITE) bit. After the write bit, The Voltage Regulator (VR) sends the acknowledge (ACK) bit. The processor then sends the VID bits code during the data phase. The VR sends the acknowledge (ACK) bit after the data phase. Finally, the processor sends the stop (Stop) sequence. After the VR has detected the stop, it performs an On-the-Fly VID transition for the addressed section(s). Refer to Table 3 for the details of SVI send byte.

RT8855 is able to manage individual power off for both VCORE and NB sections. The CPU may issue a serial VID command to power off or power on one section while the other one remains powered. In this case, the PGOOD signal remains asserted.

**Table 3. SVI Send Byte-Address and Data Phase**  
Description / Example

| bits                 | Description   |
|----------------------|---|
| <b>Address Phase</b> |   |
| 6 : 4                | Always 110b   |
| 3                    | Not Applicable, ignored.  |
| 2                    | Not Applicable, ignored.  |
| 1                    | CORE Section. (Note)<br>If set then the following data byte contains the VID code for CORE Section. |
| 0                    | NB Section. (Note)<br>If set then the following data byte contains the VID code for NB Section.     |
| <b>Data Phase</b>    |   |
| 7                    | PSI_L Flag (Active Low). When asserted, the VR is allowed to enter Power-Saving Mode.               |
| 6 : 0                | VID Code.   |

Note : Assertion in both bit 1 and 0 will address the VID code to both CORE and NB simultaneously.

Example :

| SVI Address Bits [6 : 0] | Description                        |
|--------------------------|------------------------------------|
| 1100_000                 | Should be ignored.                 |
| 1100_001                 | Set VID on VDDNB.                  |
| 1100_110                 | Set VID on VDD0 and VDD1.          |
| 1100_100                 | Set VID on VDD1.                   |
| 1100_010                 | Set VID on VDD0 or VDD (uniplane). |
| 1100_111                 | Set VID on VDDNB, VDD0 and VDD1.   |

**PWROK De-assertion**

PWROK stays low after EN signal is asserted, and the controller regulates all the planes according to the Pre-PWROK Metal VID.

PGOOD is de-asserted as long as Pre-PWROK Metal VID voltage is out of the initial voltage specifications.

**V\_FIX Mode Function**

Anytime the pin VID0/VFIXEN is pulled high, the controller enters V-FIX mode. When in V\_FIX mode, both V<sub>CORE</sub> and NB section voltages are governed by the information shown in Table 4. Regardless of the state of PWROK, the device will work in SVI mode. SVC and SVD are considered as static VID and the output voltage will be changed according to their status. Dynamic SVC/SVD-change management is provided in this condition. V\_FIX mode is intended for system debug only.

**Table 4. V\_FIX Mode and Pre-PWROK Metal VID**

| SVC | SVD | Output Voltage (V)  |            |
|-----|-----|---------------------|------------|
|     |     | Pre-PWROK Metal VID | V_FIX Mode |
| 0   | 0   | 1.1V                | 1.4V       |
| 0   | 1   | 1.0V                | 1.2V       |
| 1   | 0   | 0.9V                | 1.0V       |
| 1   | 1   | 0.8V                | 0.8V       |

**Power Ready Detection**

During start-up, RT8855 will detect V<sub>C12</sub>, V<sub>C5</sub> and EN signal. Figure 2 shows the power ready detection circuit. When V<sub>C12</sub> > 9.6V and V<sub>C5</sub> > 4.6V, POR (Power On Reset) will go high. POR is the internal signal to indicate all input powers are ready to let RT8855 and the companioned MOSFET drivers to work properly. When POR = L, RT8855 will turn off both high side and low side MOSFETs.

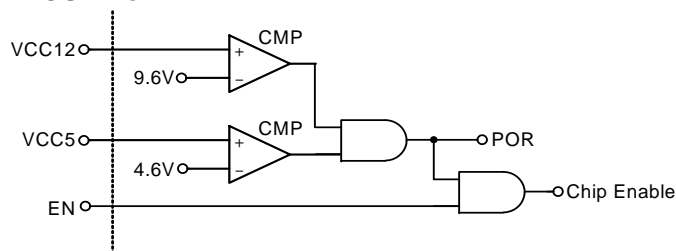


Figure 2. Circuit for Power Ready Detection

**Power-Up Sequencing**

Figure 3 and 4 are the power-up sequencing diagram of RT8855. Once power\_on\_reset is valid (POR = H), on the rising edge of the EN signal, the RT8855 detects the VID1 pin and determine to operate either in SVI or PVI mode. Figure3 shows the PVI-mode power sequence, the controller stays in T1 state waiting for valid parallel VID code sent by CPU. After receiving valid parallel VID code, V<sub>CORE</sub> continues ramping up to the specified voltage according to the VID code in T2 state. Figure 4 shows the SVI-mode power sequence, the controller samples the two serial VID pins, SVC and SVD. Then, the controller stores this value as the boot VID that is the so-called "Pre-PWROK Metal VID" in T1 state. After the processor starts with boot VID voltages, PWROK is asserted and the processor initializes the serial VID interface in T2 state. The processor uses the serial VID interface to issue VID commands to move the power planes from the boot VID values to the dual power planes in T3 state.

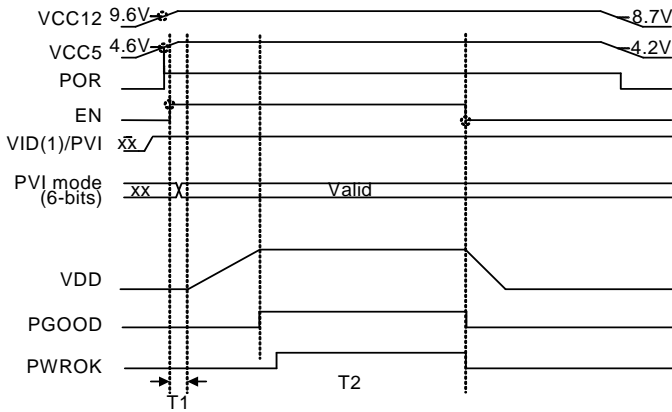


Figure 3. PVI-Mode Power-sequencing Diagram

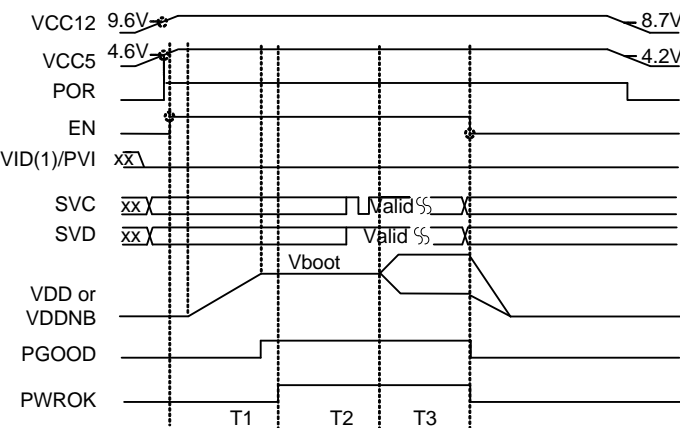


Figure 4. SVI-Mode Power-sequencing Diagram

**CORE Section- Output Current Sensing**

The RT8855 provides a low input offset current-sense amplifier (CSA) to monitor the continuous output current of each phase for V<sub>CORE</sub>. Output current of CSA (I<sub>X[n]</sub>) is used for current balance and active voltage position as shown in Figure 5. In this inductor current sensing topology, R<sub>S</sub> and C<sub>S</sub> must be set according to the equation below :

$$\frac{L}{DCR} = R_S \times C_S$$

Then the output current of CSA will follow the equation below :

$$I_X = \frac{[L \times DCR - V_{OFS\_CSA} + 235nA \times (R_{CSP} - R_{CSN})]}{R_{CSN}}$$

235nA is the typical value of the CSA input offset current. V<sub>OFS-CSA</sub> is the input offset. Usually, "V<sub>OFS-CSA</sub> + 235nA x (R<sub>CSP</sub> - R<sub>CSN</sub>)" is negligible except at very light load and the equation can be simplified as the equation below :

$$I_X = \frac{L \times DCR}{R_{CSN}}$$

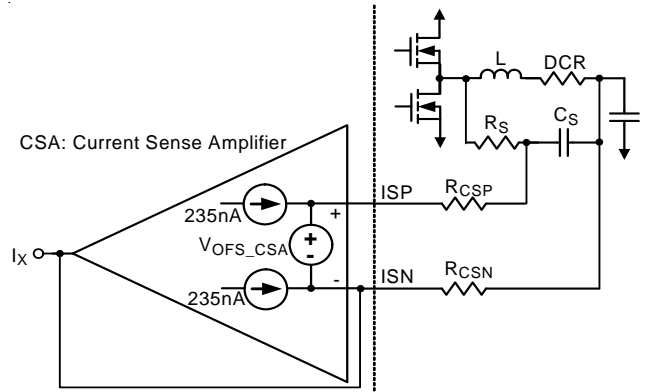


Figure 5. Current Sensing Circuit.

**CORE Section- Phase Detection**

The number of the operational phases is determined by the internal circuitry that monitors the ISN<sub>x</sub> voltages during start up. Normally, the RT8855 operates as a 4-phase PWM controller. Pull ISN<sub>4</sub> and ISP<sub>4</sub> to 5VCC programs 3-phase operation, pull ISN<sub>3</sub> and ISP<sub>3</sub> to 5VCC programs 2-phase operation, and pull ISN<sub>2</sub> and ISP<sub>2</sub> to 5VCC programs 1-phase operation. RT8855 detects the voltage of ISN<sub>4</sub>, ISN<sub>3</sub> and ISN<sub>2</sub> at rising edge of POR. At the rising edge, RT8855 detects whether the voltage of ISN<sub>4</sub>, ISN<sub>3</sub> and ISN<sub>2</sub> are higher than "VCC5-1V" respectively to decide how many phases should be active. Phase detection is only active during start up. Once POR = high, the number of operational phases is determined and latched.

**CORE Section- Switching Frequency**

Connect a resistor (R<sub>T</sub>) from the RT pin to GND can program the switching frequency of each phase. Figure 6 shows the relationship between the resistance and switching frequency.

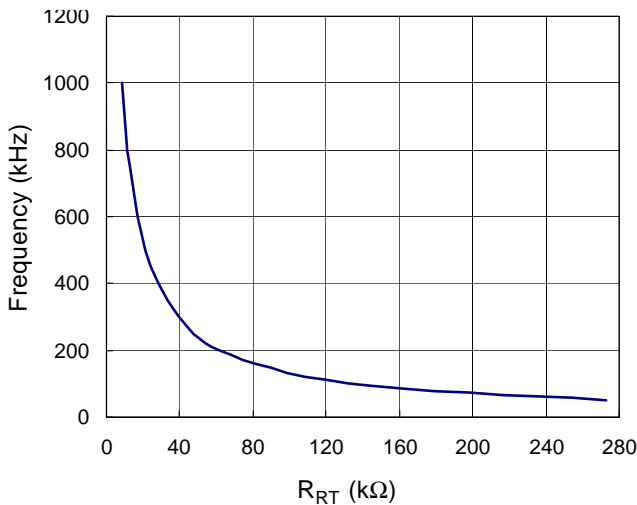


Figure 6. R<sub>RT</sub> vs. Phase switching Frequency.

**CORE Section- Differential Output Voltage Sensing**

The RT8855 uses differential voltage sensing by a high gain low offset ErrorAmp as shown in Figure 7. Connect the negative on-die CPU remote sense pin to FBRTN. Connect the positive on-die remote sense pin to FB with a resistor (R<sub>FB</sub>) The ErrorAmp compares EAP (= V<sub>DAC</sub> - V<sub>ADJ</sub>) with the V<sub>FB</sub> to regulate the output voltage.

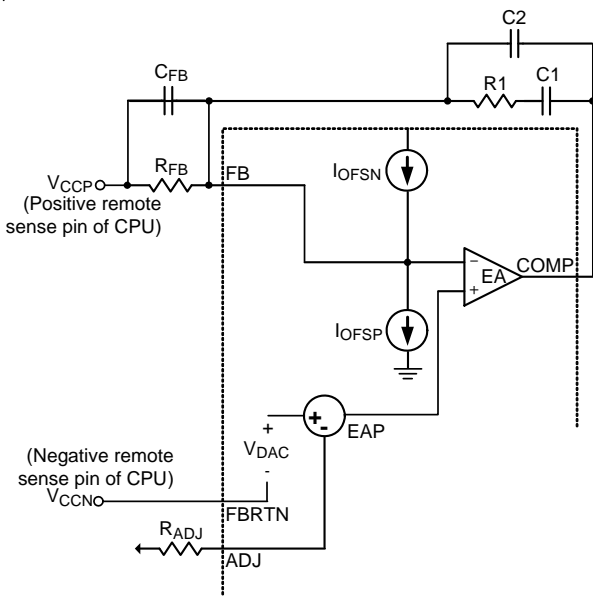


Figure 7. Circuit for V<sub>CORE</sub> Differential Sensing and No load Offset.

**CORE Section- No-Load Offset**

In Figure 7, I<sub>OFSN</sub> and I<sub>OFSN</sub> are used to generate no-load offset. Either I<sub>OFSN</sub> or I<sub>OFSN</sub> is active during normal operation. Connect a resistor from OFS pin to GND to activate I<sub>OFSN</sub>. I<sub>OFSN</sub> flows through R<sub>FB</sub> from FB pin to V<sub>CCP</sub>. In this case, negative no-load offset voltage (V<sub>OFSN</sub>) is generated.

Connect a resistor from OFS pin to 5VCC to activate I<sub>OFSN</sub>. I<sub>OFSN</sub> flows through R<sub>FB</sub> from the V<sub>CCP</sub> to FB pin. In this case, positive no-load offset voltage (V<sub>OFSN</sub>) is generated.

Beside I<sub>OFSN</sub> and I<sub>OFSN</sub>, the RT8855 generates another DC current for initial no-load negative offset. A DC current source will continuously inject typical 9uA current into the resistors connected to ADJ pin, Therefore, the effect of this 9uA current source and ADJ resistors should counted into the calculation of no-load offset :

$$V_{OFSN} = I_{OFSN} \times R_{FB} + 9\mu \times R_{ADJ}$$

$$= 0.4 \times \frac{R_{FB}}{R_{OFS}} + 9\mu \times R_{ADJ}$$

$$V_{OFSN} = I_{OFSN} \times R_{FB} - 9\mu \times R_{ADJ}$$

$$= 0.4 \times \frac{R_{FB}}{R_{OFS}} - 9\mu \times R_{ADJ}$$

**CORE Section- Programmable Load-line**

Output current of CSA is summed and averaged in RT8855. Then 0.5Σ (I<sub>X[n]</sub>) is sent to ADJ pin. Because Σ I<sub>X[n]</sub> is a PTC (Positive Temperature Coefficient) current, an NTC (Negative Temperature Coefficient) resistor is needed to connect ADJ pin to GND. If the NTC resistor is properly selected to compensate the temperature coefficient of I<sub>X[n]</sub>, the voltage on ADJ pin will be proportional to I<sub>OUT</sub> without temperature effect. In RT8855, the positive input of ErrorAmp is "V<sub>DAC</sub> - V<sub>ADJ</sub>". V<sub>OUT</sub> will follow "V<sub>DAC</sub> - V<sub>ADJ</sub>", too. Thus, the output voltage decreasing linearly with I<sub>OUT</sub> is obtained. The loadline is defined as :

$$LL(\text{loadline}) = \frac{\Delta V_{OUT}}{\Delta I_{OUT}} = \frac{\Delta V_{ADJ}}{\Delta I_{OUT}} = \frac{1}{2} \times DCR \times \frac{R_{ADJ}}{R_{CSN}}$$

Briefly, the resistance of R<sub>ADJ</sub> sets the resistance of loadline. The temperature coefficient of R<sub>ADJ</sub> compensates the temperature effect of loadline.



**CORE Section- Load Transient Quick Response**

In steady state, the voltage of  $V_{FB}$  is controlled to be very close to  $V_{EAP}$ . While a load step transient from light load to heavy load could cause  $V_{FB}$  lower than  $V_{EAP}$  by several tens of mV. In prior design, owing to limited control bandwidth, controller is hard to prevent  $V_{OUT}$  undershoot during quick load transient from light load to heavy load. RT8855 built in proprietary Burst Transient Response (BTR™) technology, that detects load transient by comparing  $V_{FB}$  and  $V_{EAP}$ . If  $V_{FB}$  suddenly drops below “ $V_{EAP} - V_{QR}$ ”,  $V_{QR}$  is a predetermined voltage. The quick response indicator QR rises up. When QR = high, RT8855 turns on all high side MOSFETs and turn off all low side MOSFETs. The sensitivity of quick response can be adjusted by the values of  $C_{FB}$  and  $R_{FB}$ . Smaller  $R_{FB}$  and/or larger  $C_{FB}$  will make QR easier to be trigger. Figure8 is the circuit and typical waveforms.

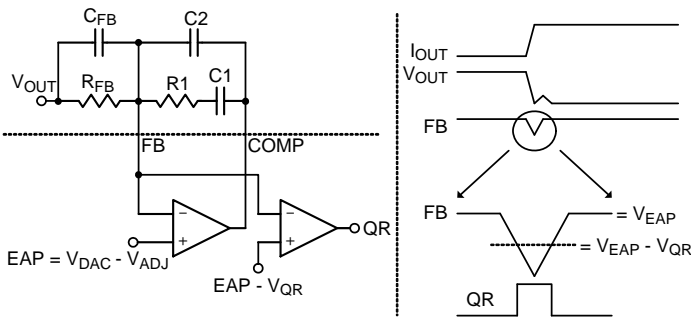


Figure 8. Load Transient Quick Response

**CORE Section- Current Balance**

In Figure9,  $I_x[n]$  is the current signal which is proportional to the current flowing through channel n. The current error signals  $I_{ERR}[n]$  ( $= I_x[n] - AVG(I_x[n])$ ) are used to raise or lower the valley of internal sawtooth waveforms (EAMP[1] to RAMP[n]) which are compared with ErrorAmp output (COMP) to generate PWM signal. To raise the valley of sawtooth waveform will decrease the PWM duty of the corresponding channel while to lower the sawtooth waveform valley will increase the PWM duty. Eventually, current flowing through each channel will be balanced.

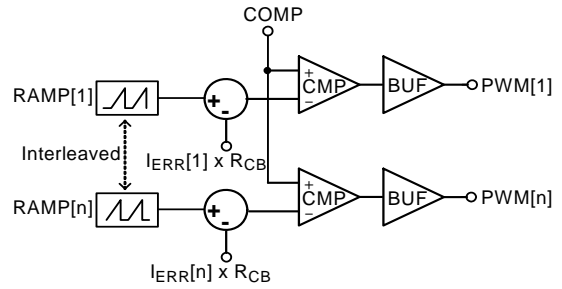


Figure 9. Circuit Channel Current Balance

**CORE Section- Phase Current Adjustment**

If phase current is not balanced due to asymmetric PCB layout of power stage, external resistors can be adjusted to correct current imbalance. Figure10 shows two types of current imbalance, constant ratio type and constant difference type. If the initial current distribution is constant ratio type, according to Equation (3), reducing  $R_{CSN}[1]$  can reduce  $I_L[1]$  and improve current balance. If the initial current distribution is the constant difference type, according to Equation (2), increasing  $R_{CSP}[1]$  can reduce  $I_L[1]$  and improve current balance.

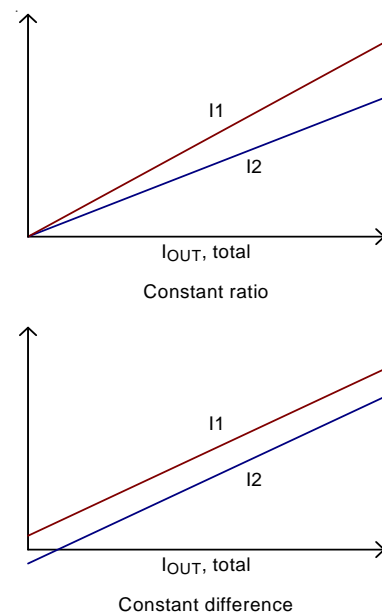


Figure 10. Category of Phase Current Imbalance

**CORE Section-Over Current Protection (OCP)**

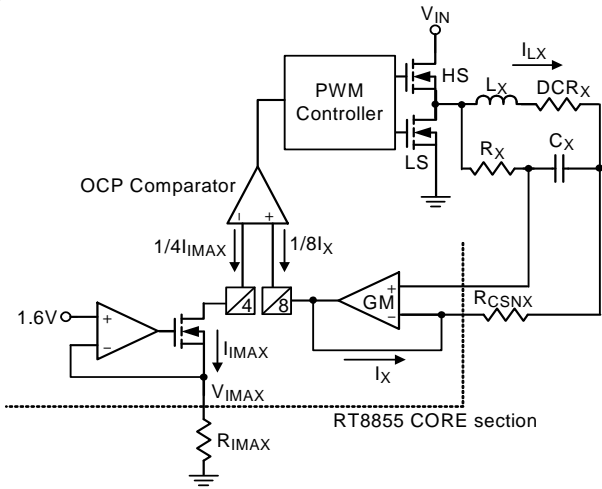


Figure 11. Over Current Protection for CORE section.

CORE section uses an external resistor  $R_{IMAX}$  connected to  $I_{MAX}$  pin to generate a reference current  $I_{IMAX}$  for over current protection as depicted in Figure 11.

$$I_{IMAX} = \frac{V_{IMAX}}{R_{IMAX}}$$

where  $V_{IMAX}$  is typical 1.6V. RT8855 senses each phase current  $I_x$  and OCP comparator compares sensed average current with the reference current. Equivalently, the maximum phase average current  $I_{LX(MAX)}$  is calculated as below :

$$\frac{1}{4} \times I_{IMAX} = \frac{1}{8} \times I_x(MAX)$$

$$I_x(MAX) = 2 \times I_{IMAX} = 2 \times \frac{V_{IMAX}}{R_{IMAX}}$$

$$I_{LX(MAX)} = I_x(MAX) \times \frac{R_{CSNX}}{DCR_x} = 2 \times \frac{V_{IMAX}}{R_{IMAX}} \times \frac{R_{CSNX}}{DCR_x}$$

Once  $I_x$  is larger than  $2 \times I_{IMAX}$ , OCP of CORE section is triggered and latched. Then, RT8855 will turn off both high side MOSFET and low side MOSFET of all channels. A 100us delay is used in OCP detection circuit to prevent false trigger.

Except the normal OCP function described above, there is another short-circuit-OCP function especially designed for short circuit protection. Since short circuit may cause catastrophic damage over a very short period, this short-circuit-OCP should have a very short delay for triggering OCP latch. Also to prevent false trigger, the trigger level

of short-circuit-OCP is designed 1.5 times of normal OCP level. Hence, the equation of short-circuit-OCP is :

$$I_{LX(MAX), short} = 1.5 \times I_{LX(MAX)} = 3 \times \frac{V_{IMAX}}{R_{IMAX}} \times \frac{R_{CSNX}}{DCR_x}$$

and the delay of short-circuit-OCP is 20us. when short-circuit-OCP is triggered, the RT8855 will turn off both high side MOSFET and low side MOSFET of all channels.

**CORE Section- Over Voltage Protection (OVP)**

The over voltage protection monitors the output voltage via the FB pin. Once  $V_{FB}$  exceeds 1.8V, OVP is triggered and latched for V<sub>CORE</sub> section. RT8855 will try to turn on each low side MOSFET and turn off each high side MOSFET to protect CPU.

**NB Section- Output Current Sensing**

The RT8855 provides low input offset current-sense amplifier (CSA) to monitor the continuous output current of NB section. Output current of CSA ( $I_{x\_NB}$ ) is used for over current detection as shown in Figure 12. In this inductor current sensing topology,  $R_{S\_NB}$  and  $C_{S\_NB}$  must be set according to the equation below :

$$\frac{L_{NB}}{DCR_{NB}} = R_{S\_NB} \times C_{S\_NB}$$

Then the output current of CSA will follow the equation below :

$$I_{x\_NB} = \frac{I_{L\_NB} \times DCR_{NB}}{R_{CSN\_NB}}$$

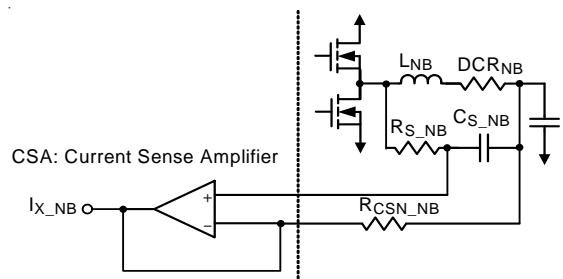


Figure 12. Current Sensing Circuit for NB Section

**NB Section- Over Current Protection (OCP)**

NB section uses an external resistor  $R_{IMAX\_NB}$  connected to  $IMAX\_NB$  pin to generate a reference current  $I_{IMAX\_NB}$  for over current protection as depicted in Figure 13.

$$I_{IMAX\_NB} = \frac{V_{IMAX\_NB}}{R_{IMAX\_NB}}$$

where  $V_{IMAX\_NB}$  is typical 1.6V. OCP comparator compares the sensed phase current  $I_{X\_NB}$  with the reference current. Equivalently, the maximum phase NB current  $I_{LX\_NB(MAX)}$  is calculated as below :

$$\frac{1}{4} \times I_{IMAX\_NB} = \frac{1}{8} \times I_{X\_NB}$$

$$I_{X\_NB} = 2 \times I_{IMAX\_NB} = 2 \times \frac{V_{IMAX\_NB}}{R_{IMAX\_NB}}$$

$$I_{LX\_NB(MAX)} = I_{X\_NB} \times \frac{R_{CSN\_NB}}{DCR_{NB}} = 2 \times \frac{V_{IMAX\_NB}}{R_{IMAX\_NB}} \times \frac{R_{CSN\_NB}}{DCR_{NB}}$$

Once  $I_{X\_NB}$  is larger than  $2 \times I_{IMAX\_NB}$ , OCP of NB section is triggered and latched. Then, RT8855 will turn off both high side MOSFET and low side MOSFET of NB section. A 100us delay is used in OCP detection circuit to prevent false trigger.

Except the normal OCP function described above, there is another short-circuit-OCP function especially designed for short circuit protection. Since short circuit may cause catastrophic damage over a very short period, this short-circuit-OCP should have a very short delay for triggering OCP latch. Also to prevent false trigger, the trigger level of short-circuit-OCP is designed 1.5 times of normal OCP level of NB section. Hence, the equation of NB section short-circuit-OCP is :

$$I_{LX\_NB(MAX), \text{ short}} = 1.5 \times I_{LX\_NB(MAX)} = 3 \times \frac{V_{IMAX\_NB}}{R_{IMAX\_NB}} \times \frac{R_{CSN\_NB}}{DCR_{NB}}$$

and the delay of short-circuit-OCP of NB section is 20us. When short-circuit-OCP is triggered at NB section, the RT8855 will turn off both high side MOSFET and low side MOSFET of NB section.

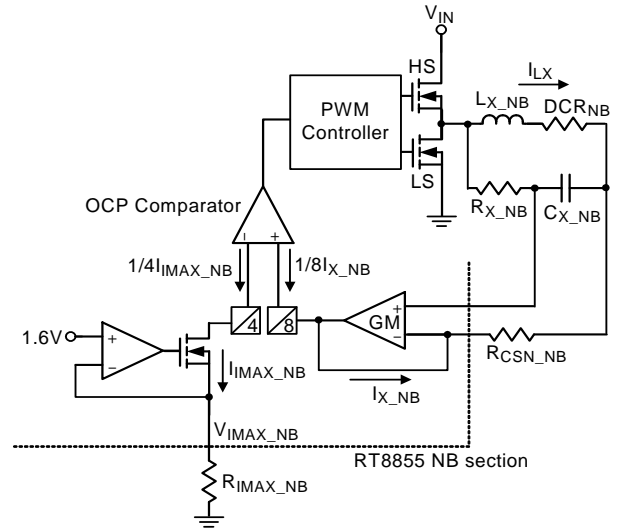


Figure 13. Over Current Protection for NB section.

**NB Section- Over Voltage Protection (OVP)**

The over voltage protection monitors the output voltage via the  $FB\_NB$  pin. Once  $V_{FB\_NB}$  exceeds 1.8V, OVP is triggered and latched for NB section. RT8855 will try to turn on low side MOSFET and turn off high side MOSFET to protect NB.

**Power Saving Indicator (PSI)**

This is an active-low flag that can be set by the CPU to allow the regulator to enter Power-Saving mode to maximize the system efficiency when in light-load conditions. The status of the flag is communicated to the controller through either the SVI bus or PS pin. RT8855 monitors the PS pin to define the PSI strategy that is the action performed by the controller when PSI is asserted.

According Figure 14, by programming different voltage on PS pin, it configures the controller to operate in one or two phases condition when PSI is asserted. Pulling-up PS pin to 3.3V through a resistor, the controller operates in only 1 phase configuration. If the 3.3V is changed to 5V, RT8855 operates in 2 phase configuration. When PSI is de-asserted, the controller will return to the original configuration. The PSI strategy is summarized as shown in Table 5.



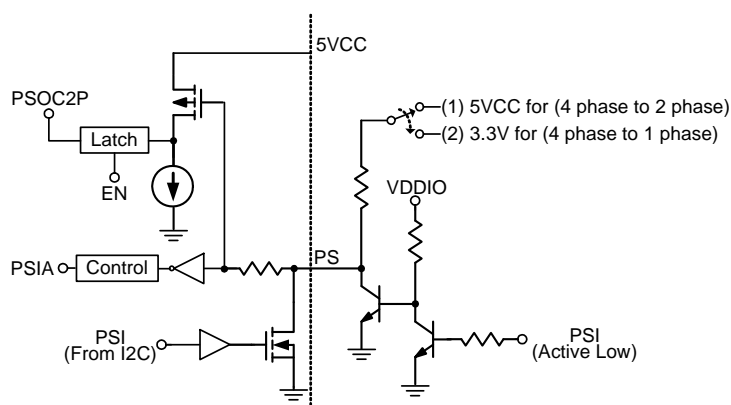


Figure 14. Power-Saving-Mode Circuit.

**Table 5. PSI Strategy**

| PS pin          | PSI Strategy                                    |
|-----------------|---|
| Pull-Up to 3.3V | Phase number is set to 1 while PSI is asserted. |
| Pull-Up to 5V   | Phase number is set to 2 while PSI is asserted. |

**PCB Layout Guideline**

Careful PCB layout is critical to achieve low switching losses and clean, stable operation. The high-power switching power stage requires particular attention. Follow these guidelines for optimum PCB layout.

Place the power components first, that includes power MOSFETs, input and output capacitors, and inductors. It is important to have a symmetrical layout for each power train, preferably with the controller located equidistant from each. Symmetrical layout allows heat to be dissipated equally across all power trains. Great attention should be paid for routing the UGATE, LGATE, and PHASE traces since they drive the power train MOSFETs using short, high current pulses. It is important to size them as large and as short as possible to reduce their overall impedance and inductance. Extra care should be given to the LGATE traces in particular since keeping their impedance and

inductance low helps to significantly reduce the possibility of shoot-through.

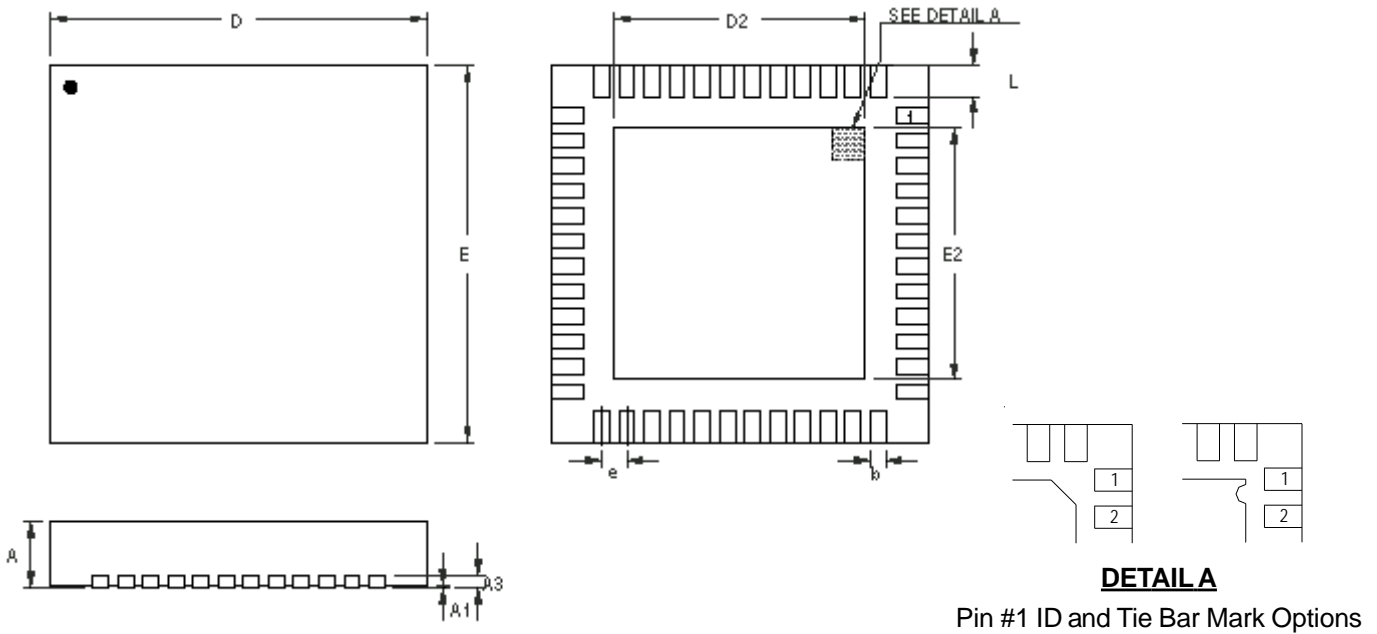
When placing the MOSFETs try to keep the source of the upper MOSFETs and the drain of the lower MOSFETs and as close as possible. Input Bulk capacitors should be placed close to the drain of the upper MOSFETs and the source of the lower MOSFETs and .

Locate the output inductors and output capacitors between the MOSFETs and the load. Route high-speed switching nodes away from sensitive analog areas (ISP, ISN, FB, FBRTN, COMP, ADJ, OFS, IMAX.....)

Keep the routing of the bootstrap capacitor short between BOOT and PHASE.

Place the snubber R&C as close as possible to the lower MOSFETs of each phase.

Outline Dimension



Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 0.700                     | 0.800 | 0.028                | 0.031 |
| A1     | 0.000                     | 0.050 | 0.000                | 0.002 |
| A3     | 0.175                     | 0.250 | 0.007                | 0.010 |
| b      | 0.200                     | 0.300 | 0.008                | 0.012 |
| D      | 6.950                     | 7.050 | 0.274                | 0.278 |
| D2     | 5.050                     | 5.250 | 0.199                | 0.207 |
| E      | 6.950                     | 7.050 | 0.274                | 0.278 |
| E2     | 5.050                     | 5.250 | 0.199                | 0.207 |
| e      | 0.500                     |       | 0.020                |       |
| L      | 0.350                     | 0.450 | 0.014                | 0.018 |

W-Type 48L QFN 7x7 Package

**Richtek Technology Corporation**

14F, No. 8, Tai Yuen 1<sup>st</sup> Street, Chupei City  
Hsinchu, Taiwan, R.O.C.  
Tel: (8863)5526789

Richtek products are sold by description only. Richtek reserves the right to change the circuitry and/or specifications without notice at any time. Customers should obtain the latest relevant information and data sheets before placing orders and should verify that such information is current and complete. Richtek cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Richtek product. Information furnished by Richtek is believed to be accurate and reliable. However, no responsibility is assumed by Richtek or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Richtek or its subsidiaries.